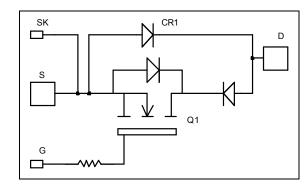


Single switch Series & parallel diodes MOSFET Power Module

$$\begin{split} V_{DSS} &= 1000 V \\ R_{DSon} &= 65 m \Omega \ typ \ @ \ Tj = 25^{\circ} C \\ I_D &= 145 A \ @ \ Tc = 25^{\circ} C \end{split}$$



Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- Power MOS 7[®] MOSFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration
- AlN substrate for improved thermal performance

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile
- RoHS Compliant

All ratings @ $T_j = 25$ °C unless otherwise specified

Absolute maximum ratings

| Symbol | Parameter | | Max ratings | Unit |
|-------------------|---|---------------------|-------------|-----------|
| $V_{ m DSS}$ | Drain - Source Breakdown Voltage | | 1000 | V |
| I_D | Cardin a Drain Carrant | $T_c = 25^{\circ}C$ | 145 | |
| | Continuous Drain Current | $T_c = 80$ °C | 110 | A |
| I_{DM} | Pulsed Drain current | | 580 | |
| V_{GS} | Gate - Source Voltage | | ±30 | V |
| R _{DSon} | Drain - Source ON Resistance | | 78 | $m\Omega$ |
| P_D | Maximum Power Dissipation $T_c = 25^{\circ}C$ | | 3250 | W |
| I_{AR} | Avalanche current (repetitive and non repetitive) | | 30 | A |
| E _{AR} | Repetitive Avalanche Energy | | 50 | m I |
| E_{AS} | Single Pulse Avalanche Energy | | 3200 | mJ |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



Electrical Characteristics

| | Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---|---------------------|---------------------------------|---|-----|-----|------|------|
| | I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 1000V$ | | | 400 | μA |
| Ī | R _{DS(on)} | Drain - Source on Resistance | $V_{GS} = 10V, I_D = 72.5A$ | | 65 | 78 | mΩ |
| | $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 20$ mA | 3 | | 5 | V |
| | I_{GSS} | Gate – Source Leakage Current | $V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±400 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---------------------|-------------------------------------|---|-----|------|-------|------|
| C_{iss} | Input Capacitance | $V_{GS} = 0V$ | | 28.5 | | |
| C_{oss} | Output Capacitance | $V_{DS} = 25V$ | | 5.08 | | nF |
| C_{rss} | Reverse Transfer Capacitance | f = 1MHz | | 0.9 | | |
| Q_{g} | Total gate Charge | $V_{GS} = 10V$ | | 1068 | | nC |
| Q_{gs} | Gate – Source Charge | $V_{\rm Bus} = 500 V$ | | 136 | | |
| Q_{gd} | Gate – Drain Charge | $I_D = 145A$ | | 692 | | |
| $T_{d(on)}$ | Turn-on Delay Time | $V_{GS} = 15V$ | | 18 | | ns |
| T_{r} | Rise Time | $V_{\text{Bus}} = 500 \text{V}$ | | 14 | | |
| T _{d(off)} | Turn-off Delay Time | $I_D = 145A$ $R_G = 0.75\Omega$ | | 140 | | |
| T_{f} | Fall Time | | | 55 | | |
| Eon | Turn-on Switching Energy | Inductive switching @ 25°C | | 4.8 | | Т |
| E_{off} | Turn-off Switching Energy | $V_{GS} = 15V, V_{Bus} = 670V$ $I_D = 145A, R_G = 0.75\Omega$ | | 2.9 | | mJ |
| Eon | Turn-on Switching Energy | Inductive switching @ 125°C $V_{GS} = 15V$, $V_{Bus} = 670V$ $I_D = 145A$, $R_G = 0.75\Omega$ | | 8 | | Т |
| E_{off} | Turn-off Switching Energy | | | 3.9 | | mJ |
| R_{thJC} | Junction to Case Thermal Resistance | | | | 0.038 | °C/W |

Series diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|------------------|-------------------------------------|--------------------------------------|------------------------|-----|------|------|------|
| V_{RRM} | Maximum Peak Repetitive Reverse Vol | imum Peak Repetitive Reverse Voltage | | | | | V |
| I_{RM} | Maximum Reverse Leakage Current | V _R =1000V | | | | 750 | μΑ |
| I_{F} | DC Forward Current | | $Tc = 80^{\circ}C$ | | 240 | | A |
| | | $I_{\rm F} = 240 A$ | | | 2 | 2.5 | |
| V_{F} | Diode Forward Voltage | $I_F = 480A$ | | | 2.2 | | V |
| | | $I_F = 240A$ | $T_j = 125$ °C | | 1.7 | | |
| 4 | Reverse Recovery Time | $T_j = 25^{\circ}C$ | | | 280 | | ma. |
| t_{rr} | | $I_F = 240A$ $T_j = 125$ | $T_j = 125$ °C | | 350 | | ns |
| 0 | Reverse Recovery Charge | $V_{R} = 667V$ $di/dt = 800A/\mu s$ | $T_j = 25$ °C | | 3.04 | | C |
| Q_{rr} | | | $T_{j} = 125^{\circ}C$ | | 14.4 | | μC |
| R_{thJC} | Junction to Case Thermal Resistance | | | | | 0.23 | °C/W |

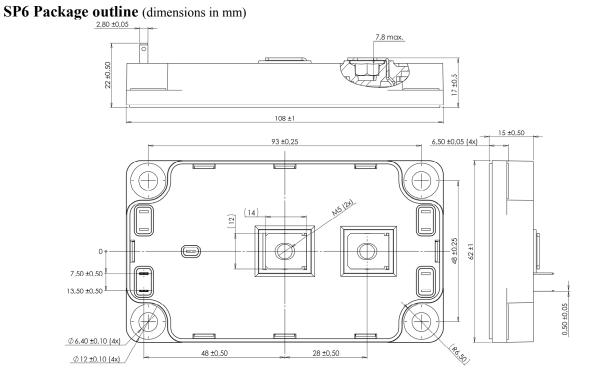


Parallel diode ratings and characteristics

| Symbol | Characteristic 7 | est Conditions | | Min | Typ | Max | Unit |
|------------------|--------------------------------------|--|------------------------|-----|------|------|------|
| V_{RRM} | Maximum Peak Repetitive Reverse Volt | Maximum Peak Repetitive Reverse Voltage | | | | | V |
| I_{RM} | Maximum Reverse Leakage Current | $V_R = 1000V$ | | | | 750 | μΑ |
| I_F | DC Forward Current | | Tc = 80°C | | 240 | | Α |
| | | $I_F = 240A$ | | | 2 | 2.5 | |
| V_{F} | Diode Forward Voltage | $I_F = 480A$ | | | 2.2 | | V |
| | | $I_F = 240A$ | $T_j = 125$ °C | | 1.7 | | |
| 4 | Reverse Recovery Time | | $T_j = 25$ °C | | 280 | | |
| t_{rr} | | $I_F = 240A$ $V_R = 667V$ | $T_j = 125$ °C | | 350 | | ns |
| 0 | | everse Recovery Charge $\frac{\text{di/dt} = 800\text{A/\mu s}}{\text{di/dt}}$ | $T_j = 25$ °C | | 3.04 | | |
| Vп | | | $T_{j} = 125^{\circ}C$ | | 14.4 | | μС |
| R_{thJC} | Junction to Case Thermal Resistance | | | | | 0.23 | °C/W |

Thermal and package characteristics

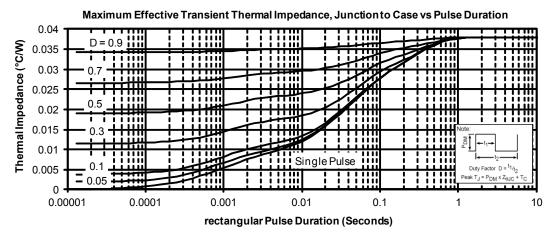
| Symbol | Characteristic | | | Min | Max | Unit | | |
|-------------|--|--------------|---------|------------------------|-----|--------|--|--|
| V_{ISOL} | RMS Isolation Voltage, any terminal to case t = 1 min, 50/60Hz | | | 4000 | | V | | |
| T_{J} | Operating junction temperature range | 2 | | -40 | 150 | | | |
| T_{JOP} | Recommended junction temperature | nditions | -40 | T _J max -25 | °C | | | |
| T_{STG} | Storage Temperature Range | | -40 | 125 | | | | |
| $T_{\rm C}$ | Operating Case Temperature | | -40 100 | | | | | |
| Torque | Mounting torque | To Heatsink | M6 | 3 | 5 | N.m | | |
| Torque | Mounting torque | For teminals | M5 | 2 | 3.5 | IN.III | | |
| Wt | Package Weight | | | | 300 | g | | |

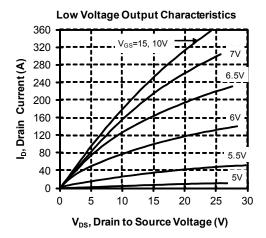


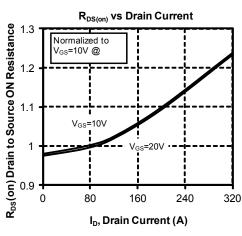
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

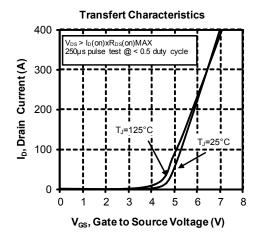


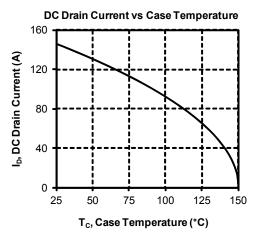
Typical Performance Curve



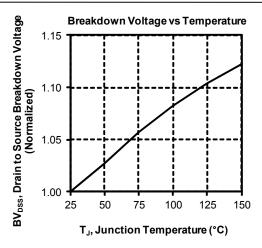


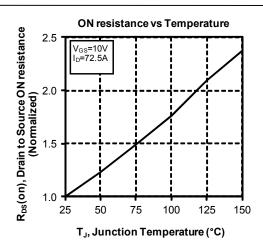


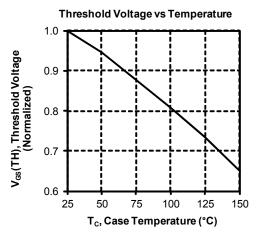


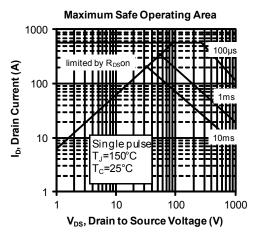


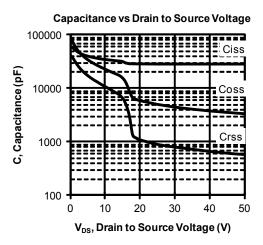


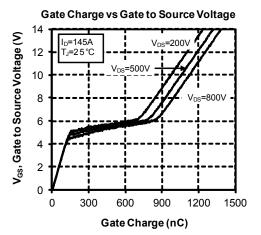




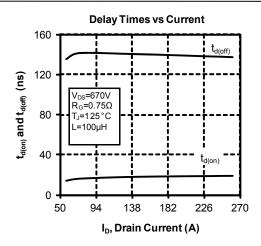


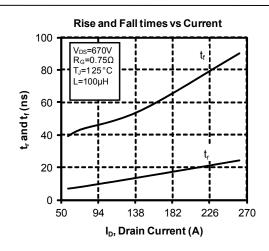


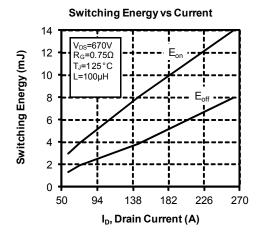


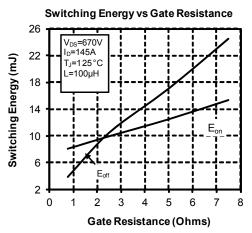


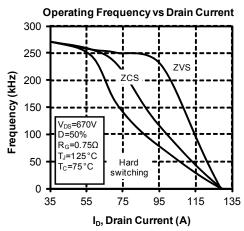














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